

DATASHEET

General Description

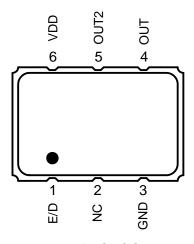
The XLP is an LVPECL Crystal Oscillator with 860fs typical phase jitter over 12kHz to 20 MHz bandwidth. Available in a wide frequency range from 0.750MHz to 1350MHz, the IDT XLP Series Crystal Oscillator utilizes a family of proprietary ASICs, with a key focus on noise reduction technologies.

The 3rd order Delta Sigma Modulator reduces noise to the levels that are comparable to traditional Bulk Quartz and SAW oscillators. With short lead-time, low cost, low noise, wide frequency range, excellent ambient performance, the XLP is an excellent choice over the conventional technologies. The XLP has stabilities as tight as ±20ppm with extremely quick delivery for both standard and custom frequencies

Features

- Frequency range: 0.750 to 1350 MHz
- Output Type: LVPECL
- Frequency Stability: ± 20ppm, ± 25ppm, ± 50ppm, or ± 100 ppm
- Supply Voltage: 2.5V or 3.3V
- Phase Jitter (1.875MHz to 20MHz): 225fs typical
- Phase Jitter (12kHz to 20MHz): 860fs typical
- Package options: 5.0mm x 3.2mm x 1.2mm (JS6)
 7.0mm x 5.0mm x 1.3mm (JU6)
- Operating Temperatures: -20°C to +70°C or -40°C to +85°C

Pin Assignment



6-pin CLCC

Pin Descriptions

Pin Number	Pin Name	Description
1	E/D	Enable/Disable ¹ (0=Output Disabled)
2	NC	No connect
3	GND	Connect to ground
4	OUT	Output
5	OUT2	Complementary Output
6	VDD	Supply voltage

^{1.} Pulled high internally.



Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the XLP. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
VDD	-0.5 to +5.0 V
E/D	-0.5 V to VDD + 0.5 V
OUT	-0.5 V to VDD + 0.5 V
Storage Temperature	-55°C to 125°C
Theta Ja (Junction to Ambient)	102°C/W – Still Air

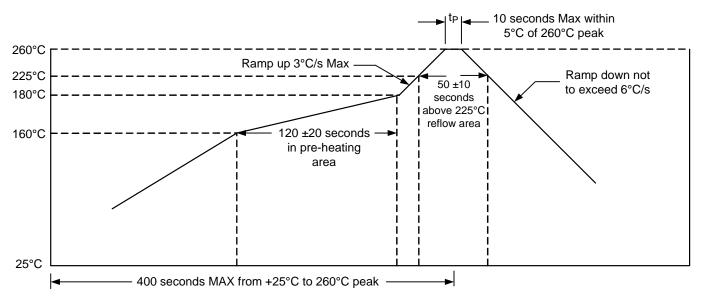
ESD Compliance

Human Body Model (HBM	1000V
Machine Model (MM)	150V

Mechanical Testing

Parameter	Test Method		
Mechanical Shock	Drop from 75cm to hardwood surface–3 times		
Mechanical Vibration	10~55Hz, 1.5mm amplitude, 1 minute sweep 2 hours each in 3 directions (X, Y, Z)		
High Temperature Burn-in	Under power @ 125°C for 2000 hours		
Hermetic Seal	He pressure: 4 ±1kgf/cm ² 2 hour soak		

Solder Reflow Profile





DC Characteristics

 $(V_{DD}= 3.3 V \pm 5\%, T_A= -20^{\circ}C \text{ to } +70^{\circ}C; -40^{\circ} \text{ to } +85^{\circ}C)$

Parameter	Symbol	Condition	Min	Тур	Max	Units
Power Supply Current	I _{DD}	Common Frequencies			120	mA
Output HIGH Voltage	V _{OH}	Standard LVPECL load	2.055		2.405	٧
Output LOW Voltage	V _{OL}	Standard LVPECL load	1.305		1.650	V
Enable/Disable Input HIGH Voltage (Output enabled)*	V _{IH}		70%V _{DD}			V
Enable/Disable Input LOW Voltage (Output disabled)	V _{IL}				30%V _{DD}	V

^{*} A pullup resistor from pin 6 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

AC Characteristics

 $(V_{DD}= 3.3 V \pm 5\%, T_A= -20^{\circ}C \text{ to } +70^{\circ}C; -40^{\circ} \text{ to } +85^{\circ}C)$

Parameter	Symbol	Condition	Min	Тур	Max	Units
Output Frequency Range	F _{OUTR}		0.750		1350	MHz
Frequency Stability		Temperature = -20°C to +70°C	±20		±100	ppm
		Temperature = -40°C to +85°C	±25		±100	ppm
Aging (1 st year)		Ta = 25°C			3	
Aging (10 years)		Ta = 25°C			10	
Output Load		To VDD - 2.0V		50		Ohms
Start-up Time	T _{ST}	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		20% to 80% V _{PP}			400	ps
Output Fall Time		80% to 20% V _{PP}			400	ps
Output Clock Duty Cycle	T _{DTCY}	50%VP-P	45		55	%
Output Enable/ Disable Time	T _{OE}				100	ns
Period Jitter, RMS	J _{PER}	Frequency = 156.25MHz		5.80		ps
Random Jitter	R _J	Frequency = 156.25MHz		1.29		ps
Deterministic Jitter	DJ	Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)		9.3		ps
Total Jitter	TJ	Sitter and digital Quality specifications)		27.7		ps
Phase Jitter (12kHz – 20MHz)	Ф _{ЛІТТЕ}	Common Frequencies		860		fs
Phase Noise Performance	φ _{NOISE}	100Hz of Carrier		-80		dBc/Hz
Frequency = 156.25MHz		1kHz of Carrier		-115		dBc/Hz
		10kHz of Carrier		-117		dBc/Hz
		100kHz of Carrier		-121		dBc/Hz
		1MHz of Carrier		-142		dBc/Hz
		10MHz of Carrier		-150		dBc/Hz
Output Frequency (Common)	F _{OUT}	10MHz of Carrier -150 100MHz, 106.25MHz, 1258MHz, 150MHz, 155.52MHz, 156.25MHz, 200M 212.5MHz, 250MHz, 300MHz, 312.5MHZ, 400MHz (Contact IDT for additional frequencies)				

Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at 25°C. We do not recommend hand soldering the devices



DC Characteristics

 $(V_{DD}= 2.5 V \pm 5\%, T_A= -20^{\circ}C \text{ to } +70^{\circ}C; -40^{\circ} \text{ to } +85^{\circ}C)$

Parameter	Symbol	Condition	Min	Тур	Max	Units
Power Supply Current	I _{DD}	Common Frequencies	33		72	mA
Output HIGH Voltage	V _{OH}	Standard LVPECL load		1.40		V
Output LOW Voltage	V _{OL}	Standard LVPECL load		0.68		V
Enable/Disable Input HIGH Voltage (Output enabled)*	V _{IH}		70%V _{DD}			V
Enable/Disable Input LOW Voltage (Output disabled)	V _{IL}				30%V _{DD}	V

^{*} A pullup resistor from pin 6 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

AC Characteristics

 $(V_{DD}= 2.5 V \pm 5\%, T_A= -20^{\circ}C \text{ to } +70^{\circ}C; -40^{\circ} \text{ to } +85^{\circ}C)$

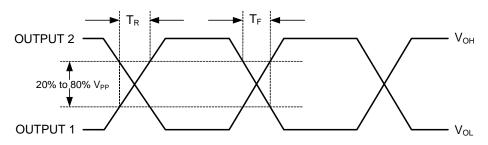
Parameter	Symbol	Condition	Min	Тур	Max	Units
Output Frequency Range	F _{OUTR}		0.750		1000	MHz
Frequency Stability		Temperature = -20°C to +70°C	±20		±100	ppm
		Temperature = -40°C to +85°C	±25		±100	ppm
Output Load		To VDD - 2.0V		50		Ohms
Start-up Time	T _{ST}	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		20% to 80% V _{PP}			400	ps
Output Fall Time		80% to 20% V _{PP}			400	ps
Output Clock Duty Cycle	T _{DTCY}	50%VP-P	45		55	%
Output Enable/ Disable Time	T _{OE}				100	ns
Period Jitter, RMS	J _{PER}	Frequency = 156.25MHz		5.12		ps
Random Jitter	R _J	Frequency = 156.25MHz		1.36		ps
Deterministic Jitter	DJ	50%VP-P Frequency = 156.25MHz		10.0		ps
Total Jitter	TJ	onter and digital equality specimeations,		29.3		ps
Phase Jitter (12kHz – 20MHz)	Ф _{JITTER}	Frequency = 156.25MHz		1200		fs
Phase Noise Performance	φ _{NOISE}	100Hz of Carrier		-83.2		dBc/Hz
Frequency = 156.25MHz		1kHz of Carrier		-106.5		dBc/Hz
		10kHz of Carrier		-115.6		dBc/Hz
		100kHz of Carrier		-120.2		dBc/Hz
		1MHz of Carrier		-136.1		dBc/Hz
		10MHz of Carrier		-145.9		dBc/Hz
Output Frequency (Standards)	F _{OUT}	100MHz, 106.25MHz, 1258MHz, 150MH 212.5MHz, 250MHz, 300MHz, 312.5MH. (Contact IDT for additional frequencies)			MHz, 200M	Hz,

Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at 25°C. We do not recommend hand soldering the devices

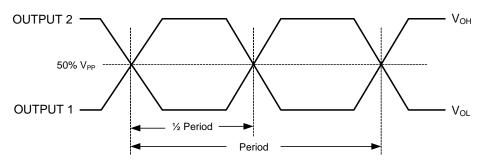


Output Waveform

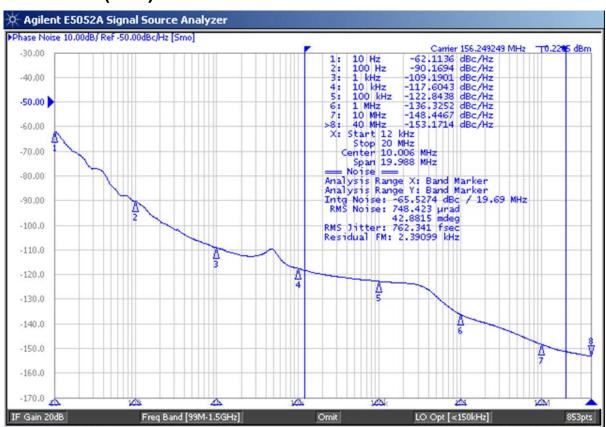
Rise Time/Fall Time Measurements



Oscillator Symmetry



Typical Phase Noise (3.3V)

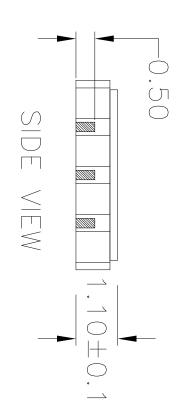


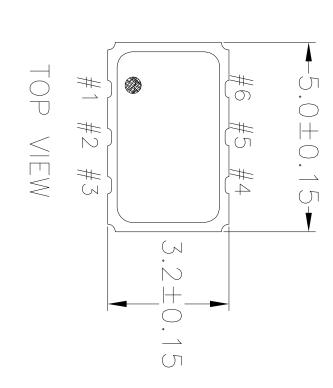


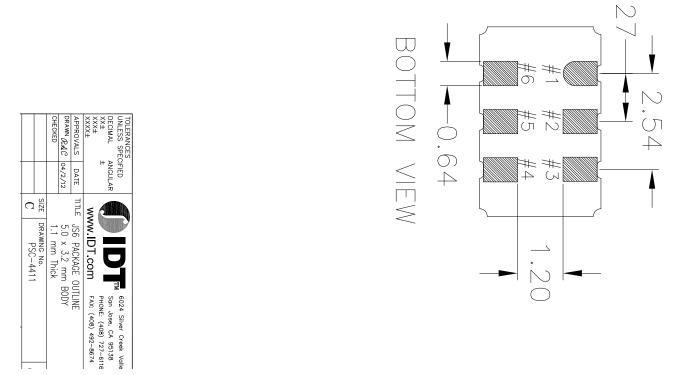
JS6 Package Outline and Dimensions

NOTES:

1. ALL DIMENSIONS IN MM.







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ΣS	07/12/12	ADDED LID IN TOP VIEW	01
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JS6 Package Outline and Dimensions (cont.)

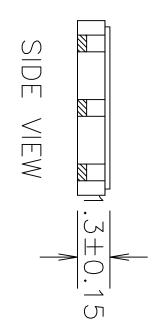
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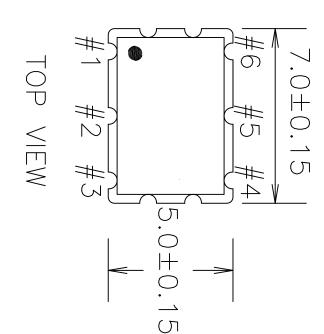
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JU6 Package Outline and Dimensions





BOTTOM VIEW

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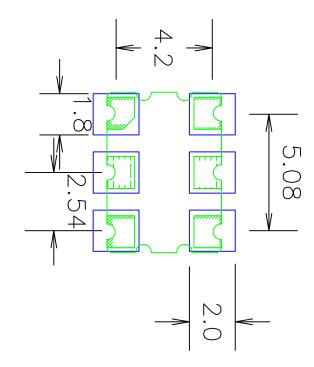
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JU6 Package Outline and Dimensions (cont.)

RECOMMENDED LAND PATTERN

- FOR SURFACE MOUNT DESIGN AND LAND PATTERN. TOP DOWN VIEW. AS VIEWED ON PCB. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN. JAND PATTERN IN BLUE. NSMD PATTERN ASSUMED. JAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT

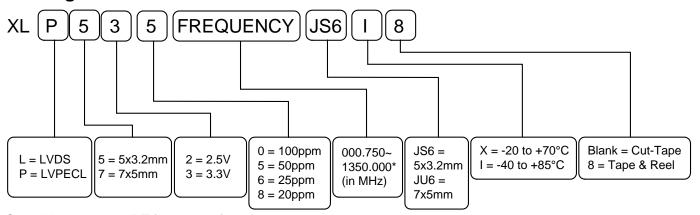


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Ordering Information



^{*} See table or contact IDT for custom frequencies

Revision History

Rev.	Date	Originator	Description of Change
Α	10/17/14	B. Chandhoke	Initial release.
В	12/10/14	B. Chandhoke	 Added 7 x 5 x 1.3mm JU6 package option and package dimension/landing pattern drawings. Updated ordering information table/graphic to show JU6 package option.



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